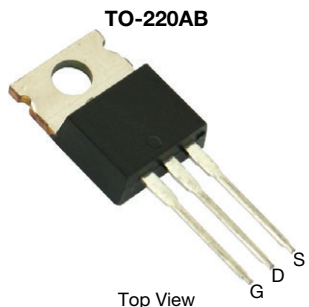


P-Channel 60 V (D-S) MOSFET



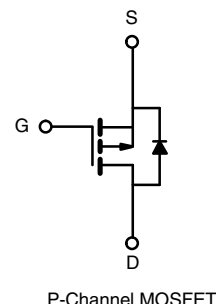
FEATURES

- TrenchFET® power MOSFET
- 100 % UIS tested
- Material categorization:
for definitions of compliance please see
www.vishay.com/doc?99912



APPLICATIONS

- Load switch



PRODUCT SUMMARY	
V_{DS} (V)	-60
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -10$ V	0.0195
$R_{DS(on)}$ max. (Ω) at $V_{GS} = -4.5$ V	0.0250
Q_g typ. (nC)	76
I_D (A) ^a	-53
Configuration	Single

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	SUP53P06-20-E3

ABSOLUTE MAXIMUM RATINGS ($T_A = 25$ °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V_{DS}	-60	V
Gate-source voltage		V_{GS}	± 20	
Continuous drain current ($T_J = 150$ °C)	$T_C = 25$ °C	I_D	-53 ^a	A
	$T_C = 70$ °C		-46.8	
	$T_A = 25$ °C		9.2 ^b	
	$T_A = 70$ °C		-8.1 ^b	
Pulsed drain current		I_{DM}	-150	mJ
Avalanche current pulse		I_{AS}	-45	
Single pulse avalanche energy		E_{AS}	101	
Continuous source-drain diode current	$T_C = 25$ °C	I_S	69 ^a	A
	$T_A = 25$ °C		2.1 ^b	
Maximum power dissipation	$T_C = 25$ °C	P_D	104.2 ^a	W
	$T_C = 70$ °C		66.7 ^a	
	$T_A = 25$ °C		3.1 ^b	
	$T_A = 70$ °C		2 ^b	
Operating junction and storage temperature range		T_J, T_{stg}	-55 to +150	°C

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum junction-to-ambient ^b	Steady state	R_{thJA}	33	40	°C/W
Maximum junction-to-case	Steady state	R_{thJC}	0.98	1.2	

Notes

a. Based on $T_C = 25$ °C



b. Surface mounted on 1" x 1" FR4 board

SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-source breakdown voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-60	-	-	V
V _{DS} temperature coefficient	ΔV _{DS} /T _J	I _D = -250 μA	-	68	-	mV/°C
V _{GS(th)} temperature coefficient	ΔV _{GS(th)} /T _J		-	-5.2	-	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA	-1	-	-3	V
Gate-source leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V	-	-	± 100	nA
Zero gate voltage drain current	I _{DSS}	V _{DS} = -60 V, V _{GS} = 0 V	-	-	-1	μA
		V _{DS} = -60 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-10	
On-state drain current ^a	I _{D(on)}	V _{DS} = -5 V, V _{GS} = -10 V	-120	-	-	A
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V, I _D = -30 A	-	0.0160	0.0195	Ω
		V _{GS} = -4.5 V, I _D = -20 A	-	0.0200	0.0250	
Forward transconductance ^a	g _{fs}	V _{DS} = -15 V, I _D = -50 A	20	-	-	S
Dynamic ^b						
Input capacitance	C _{iss}	V _{DS} = -25 V, V _{GS} = 0 V, f = 1 MHz	-	3500	-	pF
Output capacitance	C _{oss}		-	390	-	
Reverse transfer capacitance	C _{rss}		-	290	-	
Total gate charge	Q _g	V _{DS} = -30 V, V _{GS} = -10 V, I _D = -55 A	-	76	115	nC
		V _{DS} = -30 V, V _{GS} = -4.5 V, I _D = -55 A	-	38	60	
Q _{gs}	-		16	-		
Q _{gd}	-		19	-		
Gate resistance	R _g	f = 1 MHz	-	5.2	-	Ω
Turn-on delay time	t _{d(on)}	V _{DD} = -2 V, R _L = 2 Ω I _D ≡ -10 A, V _{GEN} = -10 V, R _g = 1 Ω	-	10	15	ns
Rise time	t _r		-	7	15	
Turn-off delay time	t _{d(off)}		-	70	110	
Fall time	t _f		-	40	60	
Drain-Source Body Diode Characteristics						
Continuous source-drain diode current	I _S	T _C = 25 °C	-	-	-69	A
Pulse diode forward current ^a	I _{SM}		-	-	-150	
Body diode voltage	V _{SD}	I _S = -30 A	-	-1	-1.5	V
Body diode reverse recovery time	t _{rr}	I _F = -50 A, di/dt = 100 A/μs, T _J = 25 °C	-	45	68	ns
Body diode reverse recovery charge	Q _{rr}		-	59	120	nC
Reverse recovery fall time	t _a		-	29	-	ns
Reverse recovery rise time	t _b		-	16	-	

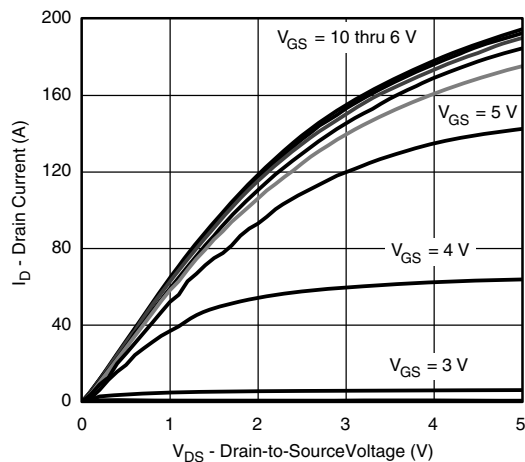
Notes

- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$
b. Guaranteed by design, not subject to production testing

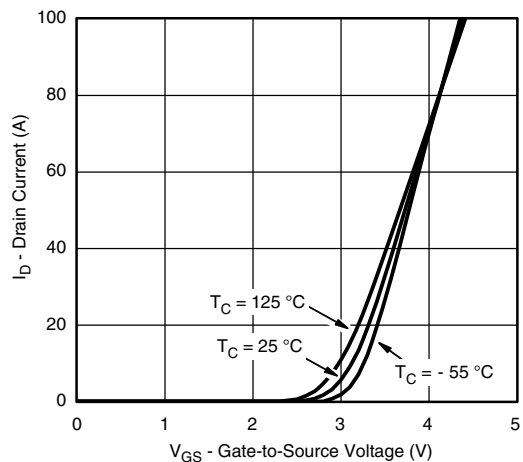
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



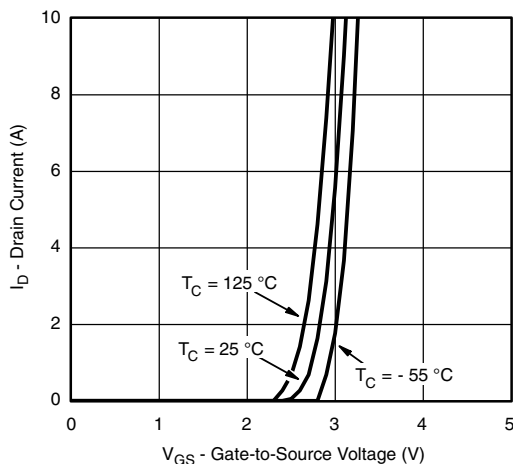
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



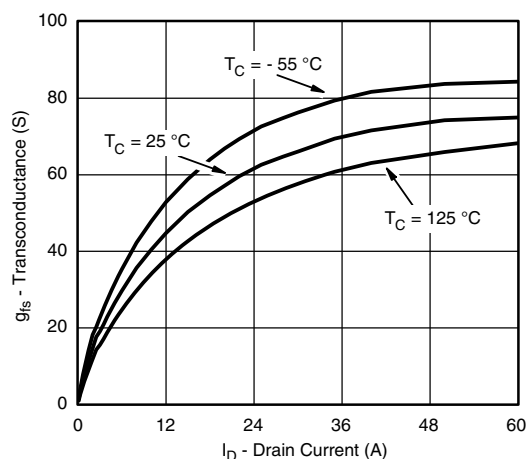
Output Characteristics



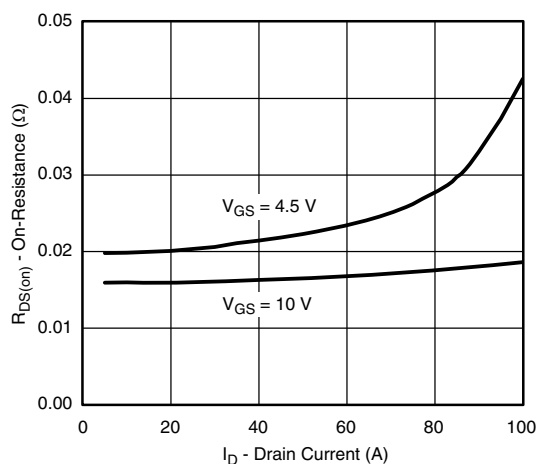
Transfer Characteristics



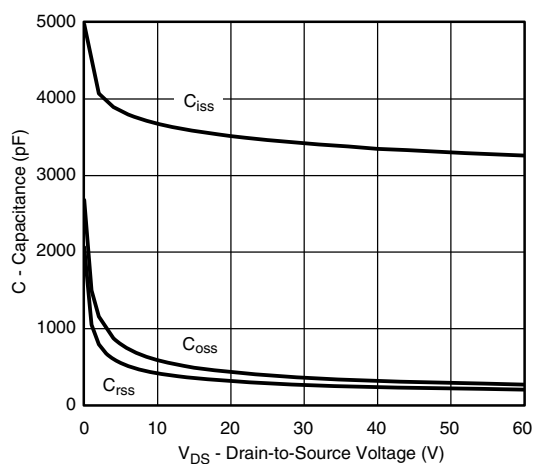
Transfer Characteristics



Transconductance



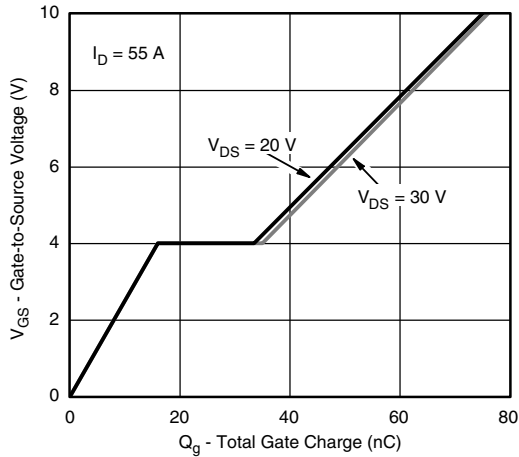
On-Resistance vs. Drain Current



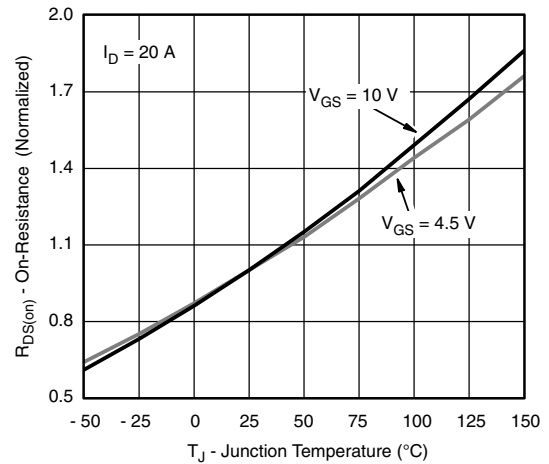
Capacitance



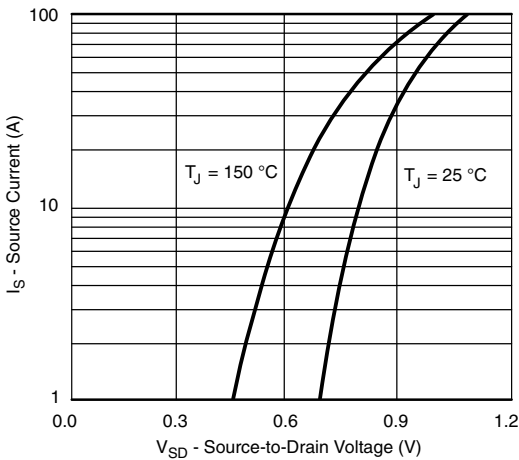
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



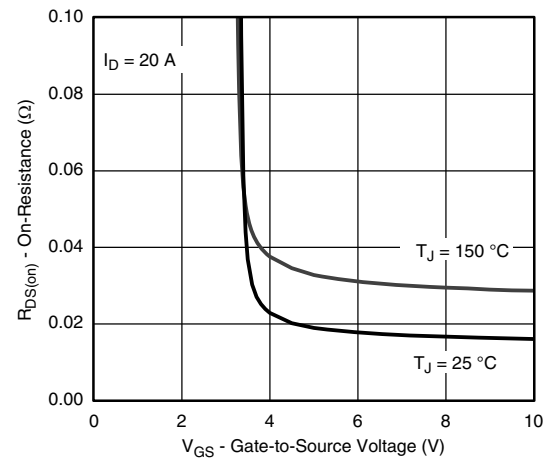
Gate Charge



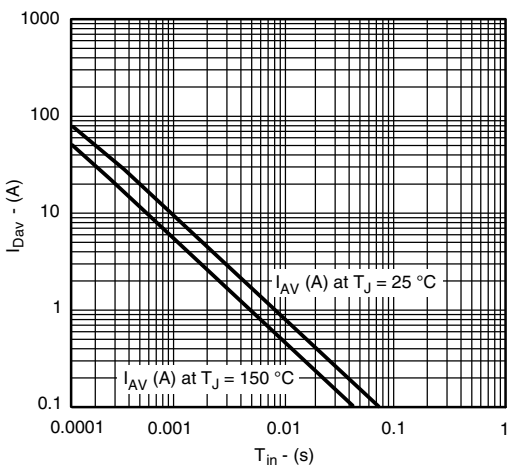
On-Resistance vs. Gate-to-Source Voltage



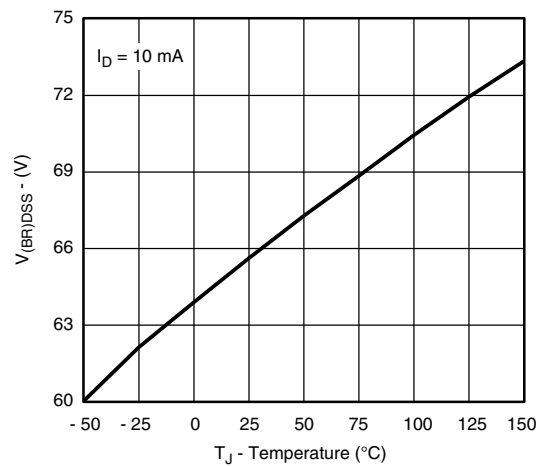
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage



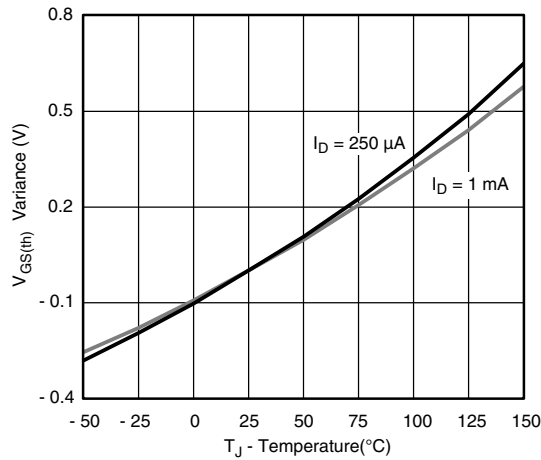
Single Pulse Avalanche Current Capability vs. Time



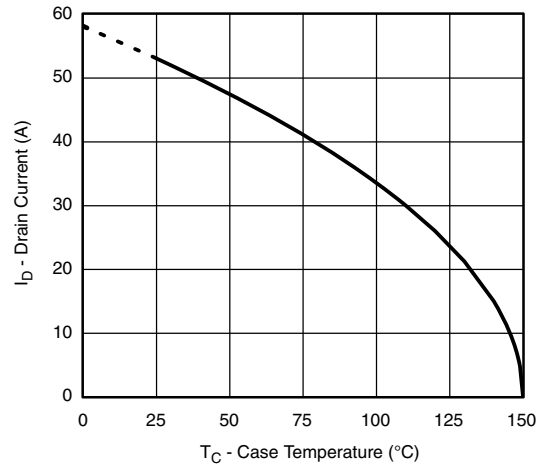
Drain-Source Breakdown Voltage vs. Junction Temperature



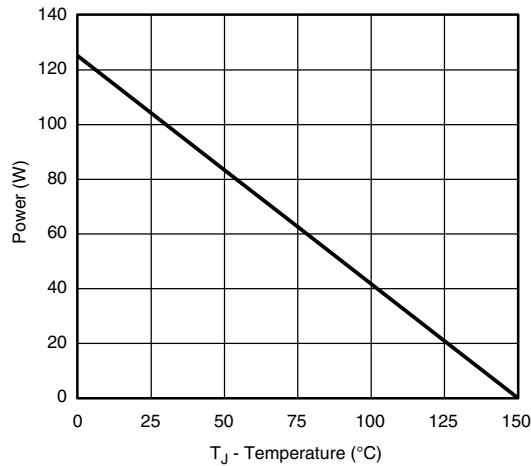
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



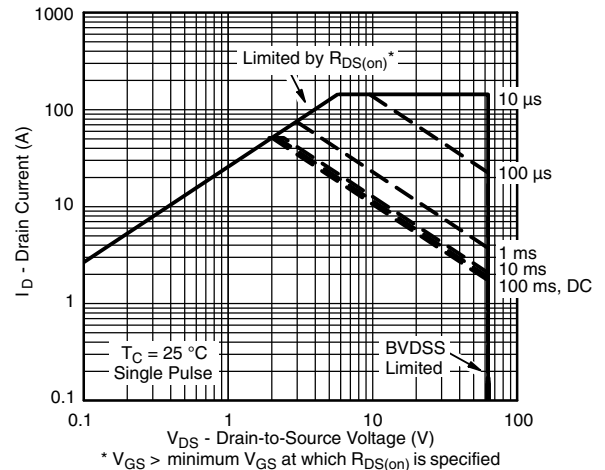
Threshold Voltage



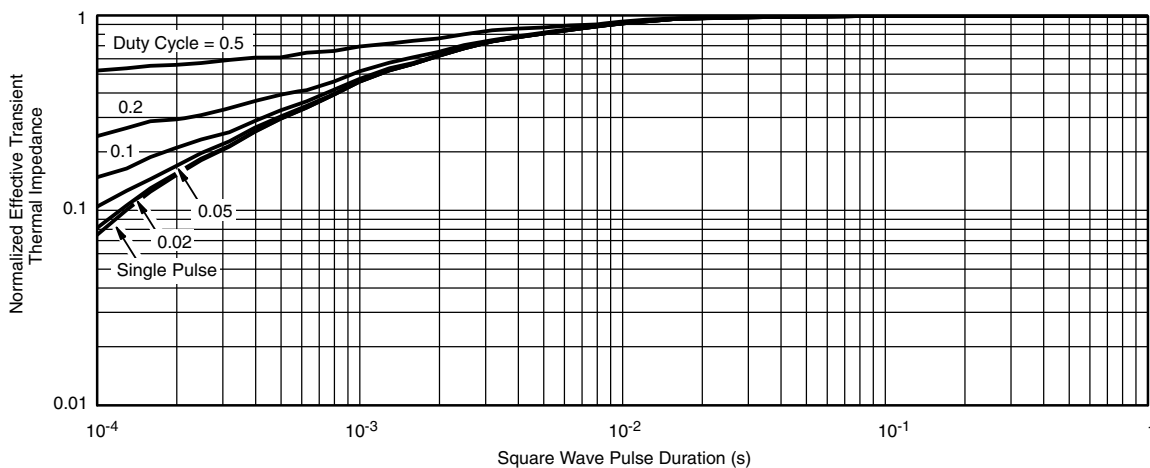
Max. Drain Current vs. Case Temperature



Power Derating, Junction-to-Case



Safe Operating Area, Junction-to-Case

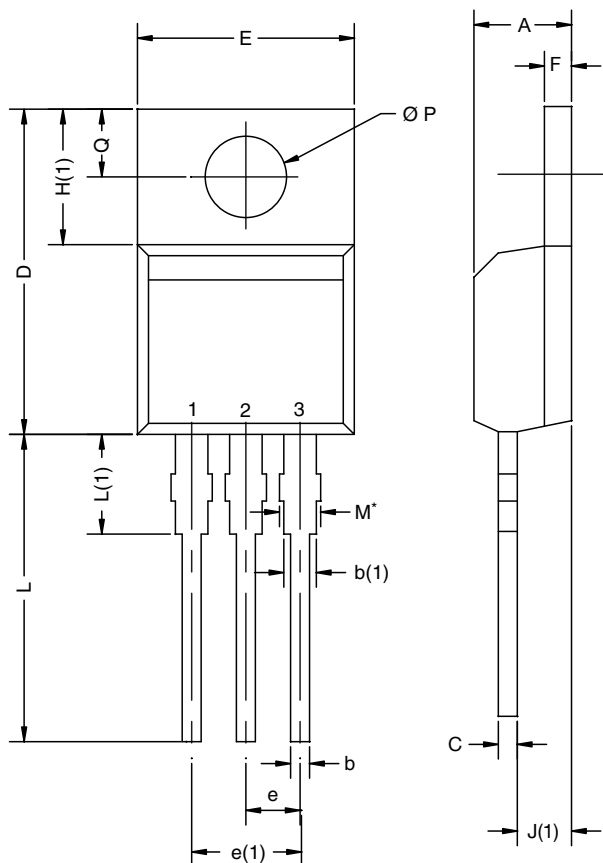


Normalized Thermal Transient Impedance, Junction-to-Case

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TO-220AB

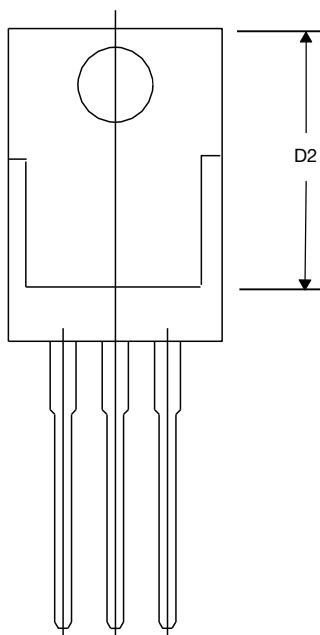


DIM.	MILLIMETERS		INCHES	
	MIN.	MAX.	MIN.	MAX.
A	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
c	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
E	10.04	10.51	0.395	0.414
e	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
Ø P	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118

ECN: T14-0413-Rev. P, 16-Jun-14
DWG: 5471

Note

* M = 1.32 mm to 1.62 mm (dimension including protrusion)
Heatsink hole for HVM





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